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SHARP

OPTO-ANALOG DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

PHOTOCOUPLER

MODEL No.

PC817

Business dealing name

PC817XNNSZ0F
PC817X1NSZ0F
PC817X2NSZ0F
PC817X3NSZ0F
PC817X4NSZ0F
PC817X5NSZ0F
PC817X6NSZ0F
PC817X7NSZ0F
PC817X8NSZ0F
PC817X9NSZ0F
PC817X0NSZ0F

Specified for

Enclosed please find copies of the Specifications which consists of 11 pages including cover. This specification sheets and attached sheets shall be both side copy. After confirmation of the contents, please be sure to send back _____ copies of the Specifications with approving signature on each.

CUSTOMER'S APPROVAL

DATE

BY

PRESENTED

DATE

BY

x 14, D.

H. Imanaka, Department General Manager of Engineering Dept., II Opto-Analog Devices Div. ELECOM Group SHARP CORPORATION



Product name :

PHOTOCOUPLER

Model No.: PC817

Business dealing name

PC817XNNSZ0F PC817X1NSZ0F PC817X2NSZ0F PC817X3NSZ0F PC817X4NSZ0F PC817X5NSZ0F PC817X5NSZ0F PC817X7NSZ0F PC817X7NSZ0F PC817X8NSZ0F PC817X9NSZ0F PC817X0NSZ0F

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
 - · OA equipment Audio visual equipment · Home appliances
 - · Telecommunication equipment (Terminal) · Measuring equipment

• Tooling machines • Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;
 - · Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals Gas leakage sensor breakers Rescue and security equipment Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;
 - · Space equipment · Telecommunication equipment (for trunk lines)
 - · Nuclear power control equipment · Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC817series(Lead-Free Type).

2.	Outline	Refer to the attached sheet, page 3.
3.	Ratings and characteristics	Refer to the attached sheet, page 4, 5.
4.	Reliability	Refer to the attached sheet, page 6.
5.	Outgoing inspection	Refer to the attached sheet, page 7.

6. Supplement

6.3

- 6.1 Isolation voltage shall be measured in the following method.
 - (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
 - (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.(It is recommended that the isolation voltage be measured in insulation oil.)
- 6.2 Package specifications Refer to the attached sheet, page 8, 9.
 - Business dealing name ("O" mark indicates business dealing name of ordered product)

Ordered product	Business dealing name	Rank mark	Ic (mA)
5. 5.	PC817XNNSZ0F	with or without	2.5 to 30
	PC817X1NSZ0F	А	4.0 to 8.0
	PC817X2NSZ0F	В	6.5 to 13
	PC817X3NSZ0F	С	10 to 20
	PC817X4NSZ0F	D	15 to 30
	PC817X5NSZ0F	A or B	4.0 to 13
	PC817X6NSZ0F	B or C	6.5 to 20
	PC817X7NSZ0F	C or D	10 to 30
	PC817X8NSZ0F	A, B or C	4.0 to 20
	PC817X9NSZ0F	B, C or D	6.5 to 30
	PC817X0NSZ0F	A, B, C or D	4.0 to 30

Test conditions I_F=5mA V_{CE}=5V Ta=25°C

6.4 This Model is approved by UL.

Approved Model No. : PC817

- UL file No. : E64380
- 6.5 This product is not designed against irradiation.This product is assembled with electrical input and output.This product incorporates non-coherent light emitting diode.
- 6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_s, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform) 6.7 Brominated flame retardants

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.

7. Notes

Precautions for photocouplers : Attachment-1



2. Outline





3. Ratings and characteristics

3.1 Absolute maximum ratings

bsolute n	naximum ratings			Ta=25℃
Parameter		Symbol	Rating	Unit
	*1 Forward current	I _F	50	mA
Input	*2 Peak forward current	I _{FM}	1	A
	Reverse voltage	V _R	6	V
	*1 Power dissipation	Р	70	mW
Output	Collector-emitter voltage	V _{CEO}	80	V
	Emitter-collector voltage	V _{ECO}	6	V
	Collector current	I _c	50	mA
	*1 Collector power dissipation	P _c	150	mW
*1 Total power dissipation		P _{tot}	200	mW
Operating temperature		T _{opr}	-30 to +100	°C
Storage temperature *3 Isolation voltage *4 Soldering temperature		T _{stg}	-55 to +125	°C
		V _{iso(ms)}	5	kV
		T _{sol}	270	°C

The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4. *1

Pulse width $\leq 100 \,\mu$ s, Duty ratio : 0.001 (Refer to Fig. 5) *2

AC for 1 min, 40 to 60%RH *3

*4 For 10 s

3.2 Electro-optical characteristics

Electro-	optical characteristics					Ta=	=25℃
Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F	I _F =20mA	-	1.2	1.4	V
	Peak forward voltage	V _{FM}	I _{FM} =0.5A	-		3.0	V
	Reverse current	I _R	V _R =4V	-	-	10	μA
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF
Output	Dark current	I _{CEO}	V _{CE} =50V, I _F =0	-		100	nA
	Collector-emitter breakdown voltage	BV _{CEO}	I _c =0.1mA I _I =0	80		-	V
	Emitter-collector breakdown voltage	BV _{ECO}	$I_{E}=10 \ \mu \text{ A}, I_{F}=0$	6		-	V
	Collector current	I _c	I _F =5mA, V _{CE} =5V	2.5	-	30	mA
	Collector-emitter saturation voltage	V _{CE(sat)}	I _F =20mA I _c =1mA	-	0.1	0.2	V
	Isolation resistance	R _{ISO}	DC500V 40 to 60%RH	5×10^{10}	1011	-	Ω
Transfer charac-	Floating capacitance	C _f	V=0, f=1MHz	-	0.6	1.0	pF
teristics	Cut-off frequency	f _c	V_{CE} =5V, I_c =2mA R _L =100 Ω , -3dB	-	80		kHz
	Rise time	tr	V _{CE} =2V I _c =2mA	-	4	18	μs
	Fall time	t _r	$R_L=100 \Omega$	· -	3	18	μs

4/9









4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level : 90% LTPD : 10 or 20

Test Items	Condition	Failure Judgment Criteria	Samples (n) Defective (C)	
Solderability *2	245±3℃, 5s		n=11, C=0	
Caldening best	(Flow soldering) 270°C, 10 s		n=11, C=0	
Soldering heat	(Soldering by hand) 400°C, 3 s		II-11, C-0	
Terminal strength (Tension)	Weight: 5N5 s/each terminal V_F >U×1.2 I_R >U×2		n=11, C=0	
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	I _{CEO} >U×2	n=11, C=0	
Mechanical shock	15 km/s ² , 0.5ms 3 times/±X, ±Y, ±Z direction	$- I_{C} < L \times 0.7$ $V_{CE(sat)} > U \times 1.2$	n=11, C=0	
Variable frequency vibration	100 to 2000 to 100Hz/4 min 200m/s ² 4 times/X, Y, Z direction		n=11, C=0	
Temperature cycling	1 cycle -55 ℃ to +125 ℃ (30 min) (30 min) 20 cycles test	U: Upper specification limit	n=22, C=0	
High temp. and high Humidity storage	+85°C, 85%RH, 1000h	L: Lower specification limit	n=22, C=0	
High temp. storage	+125 °C, 1000h		n=22, C=0	
Low temp. storage	-55 °C, 1000h		n=22, C=0	
Operation life	I _F =50mA, P _{tot} =200mW Ta=25 °C, 1000h		n=22, C=0	

*1 Test method, conforms to EIAJ ED 4701.

*2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.

*3 Terminal bending direction is shown below.





5. Outgoing inspection

- 5.1 Inspection items
- (1) Electrical characteristics

 V_F , I_R, I_{CEO}, $V_{CE(sat)}$, I_c, R_{ISO}, V_{iso}

- (2) Appearance
- 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25



6.2 Package specification

6.2.1 Package materials

No.	Name	Materials	Purposes
1	Sleeve	HIPS with preventing static electricity	Products packaged
2	Stopper	Styrene-Erastomer	Products fixed
3	Packing case	Corrugated cardboard	Sleeve packaged
4	Kraft tape	Paper	Lid of packing case fixed
5	Label	Paper	Model No.,(Business dealing name),Lot No., Quantity, country of origin, Company name and inspection date specified

6.2.2 Package method

- (1) MAX. 100pcs. of products shall be packaged in a sleeve (1) and both of sleeve edges shall be fixed by stoppers (2).
- (2) MAX. 20 sleeves (Product : 2000pcs.) above shall be packaged in a packing case ③.
- (3) Model No., quantity, inspection date and lot No. shall be marked on the label (5) and this label shall be put on the side of the packing case.
- (4) Case shall be closed with the lid and enclosed with kraft tape ④.

6.2.3 Sleeve ① outline dimensions



Note 1) Thickness: 0.5 ± 0.2 mm

- 2) Process with applying antistatic agent.
- 3) Unless otherwise specified tolerances shall be ± 0.5 mm.

(However except for deformation due to the stopper in sleeve.)

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6.2.4 Packaging case outline dimensions



Regular packing mass : Approx. 860g

(): Reference dimensions

PC817X*N

Precautions for Photocouplers

1 Cleaning

(1) Solvent cleaning : Solvent temperature 45°C or less Immersion for 3 min or less

- (2) Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition and confirm that any defect doesn't occur before starting the ultrasonic cleaning.
- (3) Applicable solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol
 When the other solvent is used, there are cases that the packaging resin is eroded.
 Please use the other solvent after thorough confirmation is performed in actual using condition.

2. Circuit design

- 2.1 The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit in consideration of the degradation of the light emission power of the LED. (50%/5years)
- 2.2 There are cases that the deviation of the CTR and the degradation of the relative light emission power of the LED increase when the setting value of I_F is less than 1.0mA. Please design the circuit in consideration of this point.

3. Precautions for Soldering

 In the case of flow soldering (Whole dipping is possible) It is recommended that flow soldering should be at 270°C or less for 10 s or less (Pre-heating : 100 to 150°C, 30 to 80s). (2 times or less)

(2) In the case of hand soldering

What is done on the following condition is recommended.(2 times or less) Soldering iron temperature : 400°C or less Time : 3s or less

(3) Other precautions

Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance.